

Highly photostable organic distributed feedback lasers fabricated by thermal nanoimprint

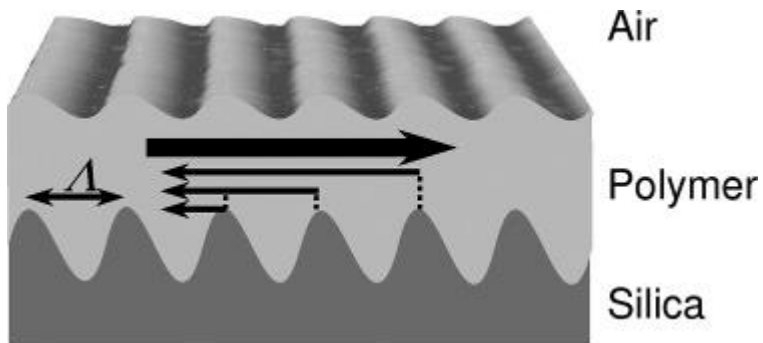
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Navarro-Fuster², M.G. Ramírez², P.G. Boj², I. Vragovic², J.M. Villalvilla²,
J.A. Quintana², M.A. Díaz-García²**

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²Instituto Universitario de Materiales de Alicante

Basic elements

- **Pump** (optical): pulsed Nd:YAG laser (10 ns, 10 Hz) operating at 532 nm.
- **Active medium**: polystyrene doped with 0.5 wt% of a perylendiimide derivative (PDI).
- **Resonator**: distributed feedback (DFB) grating

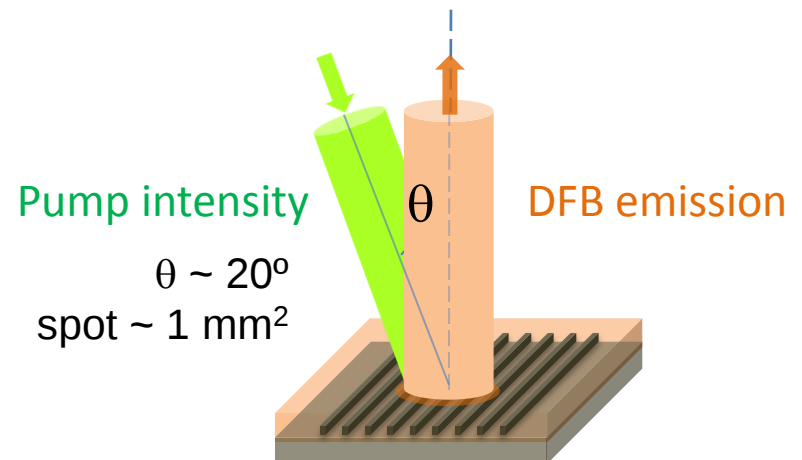


Light propagating in a waveguide mode is scattered from the periodic structure to create a diffracted wave propagating in some new direction.

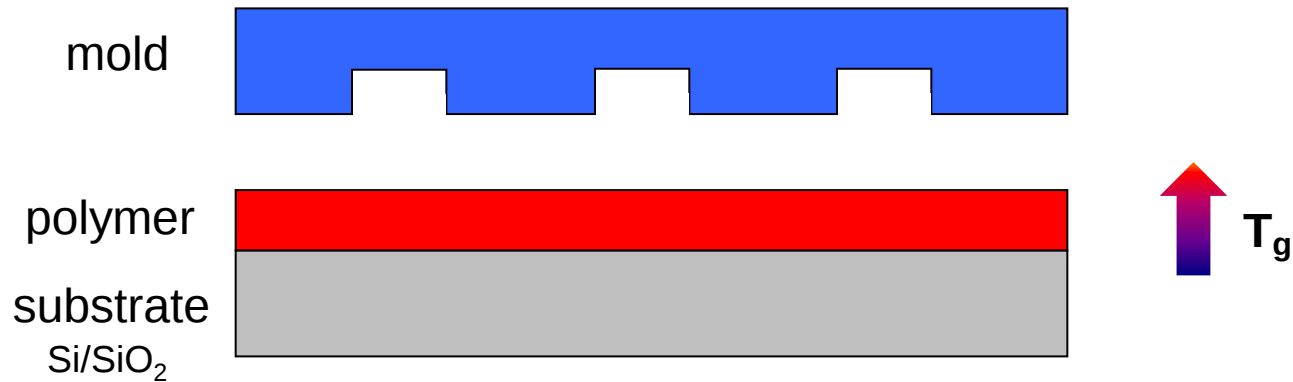
$$m \lambda_{\text{Bragg}} = 2n_{\text{eff}} \Lambda$$

$$m = 2$$

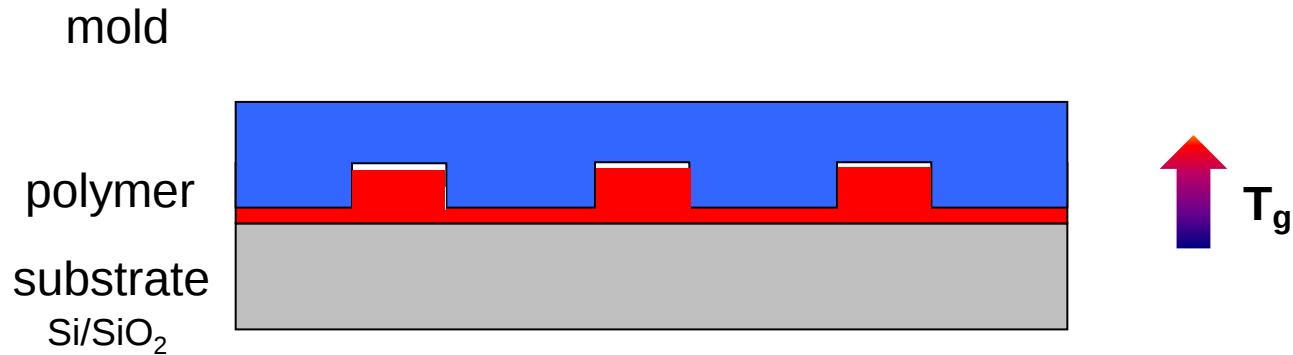
$$\Lambda = 368 \text{ nm}$$



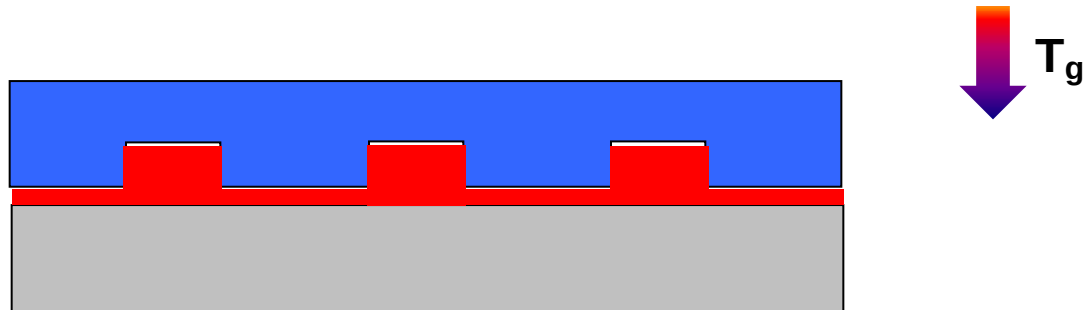
Fabrication of the resonator: Thermal Nanoimprint Lithography



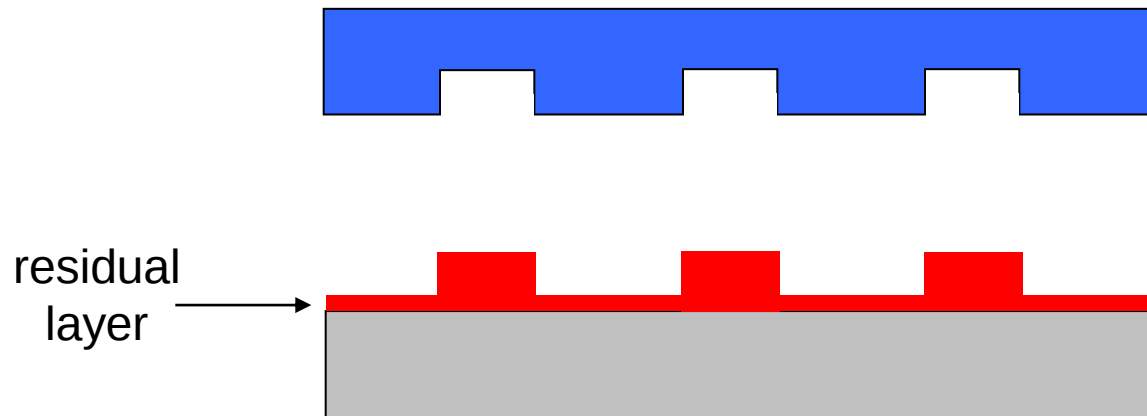
Fabrication of the resonator: Thermal Nanoimprint Lithography



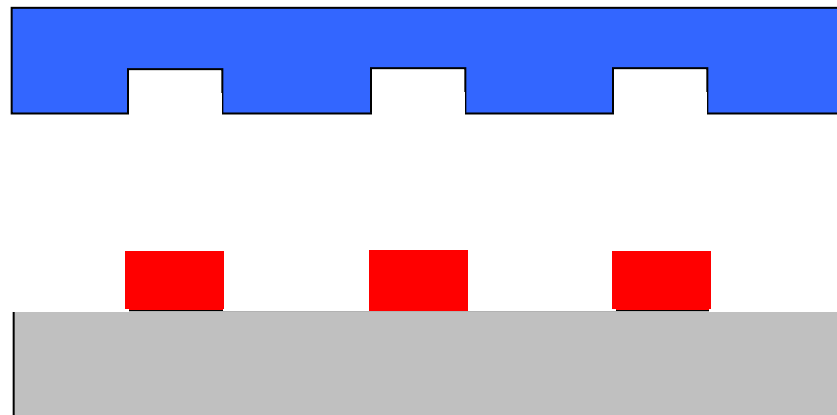
Fabrication of the resonator: Thermal Nanoimprint Lithography



Fabrication of the resonator: Thermal Nanoimprint Lithography

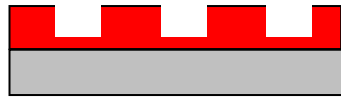


Fabrication of the resonator: Thermal Nanoimprint Lithography

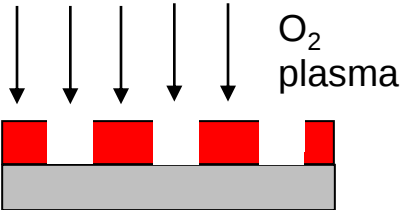


Plasma

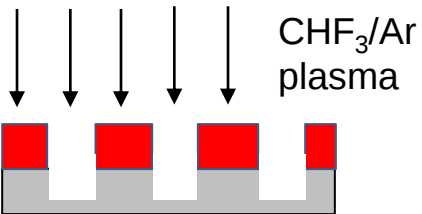
SiO₂ gratings



NIL onto mr-I8030E



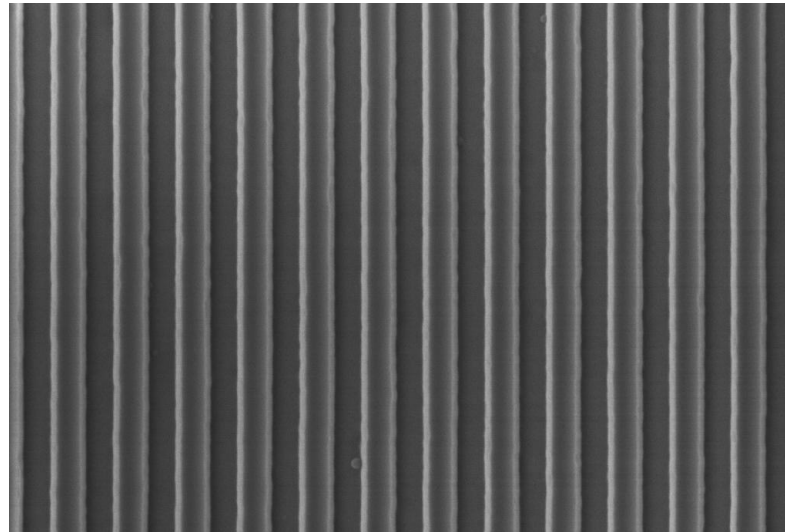
Residual layer etching



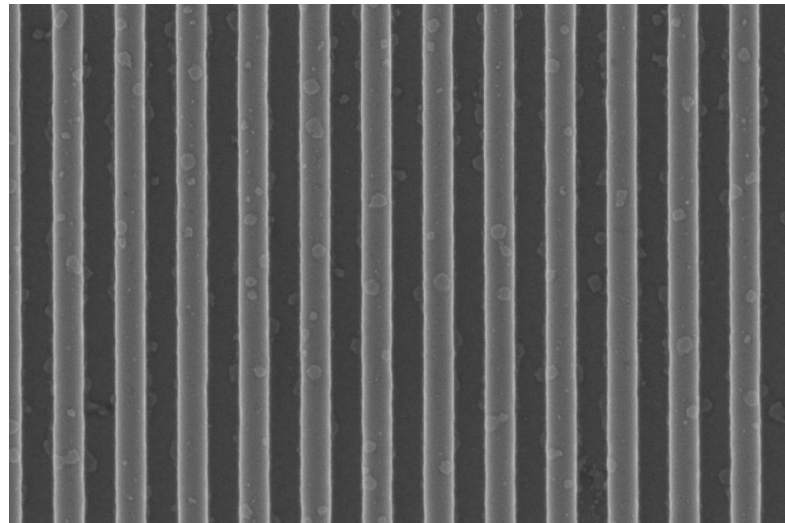
SiO₂ etching



Spin-coating of the doped PS

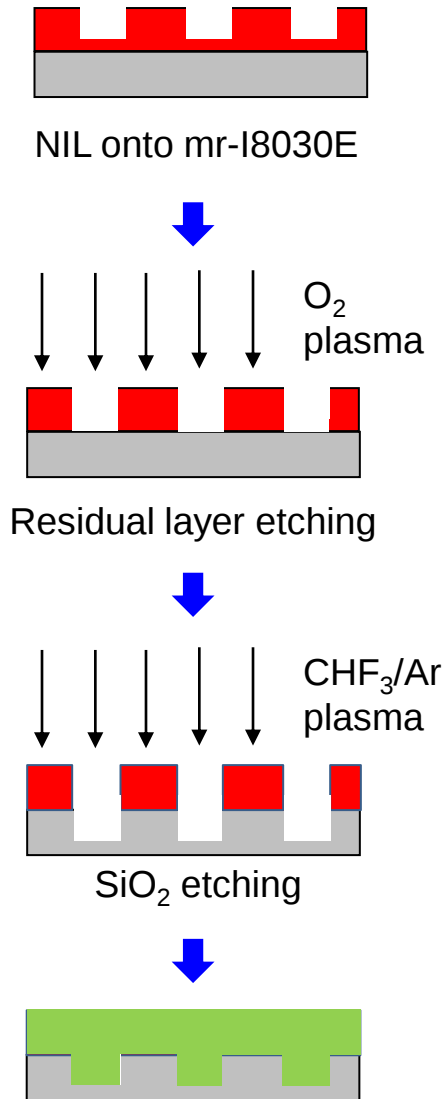


SiO₂

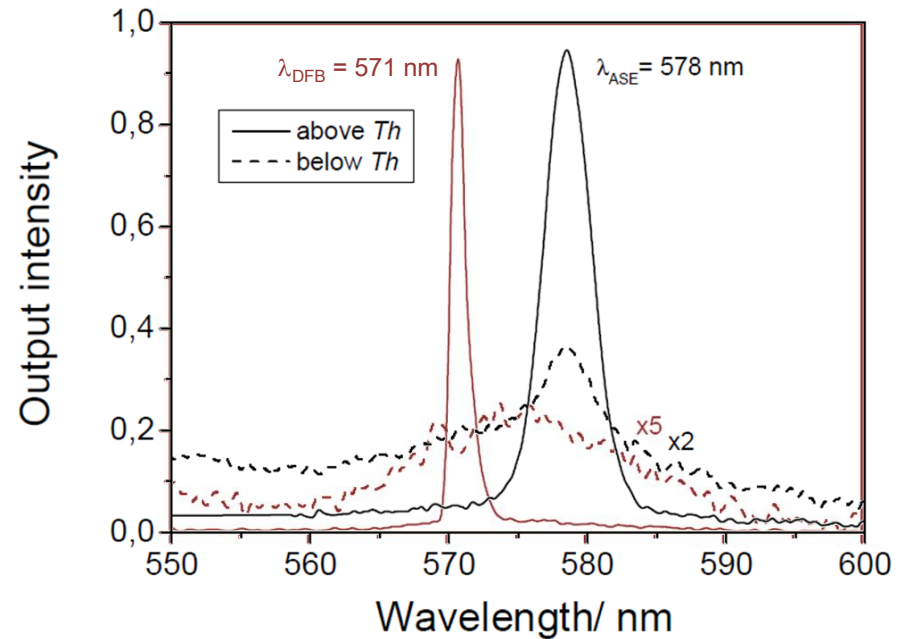


Si stamp

SiO₂ gratings



0.6 μm thickness



— Without resonator — With resonator

$\lambda_{\text{ASE}} = 578 \text{ nm}$

$\lambda_{\text{DFB}} = 571 \text{ nm}$

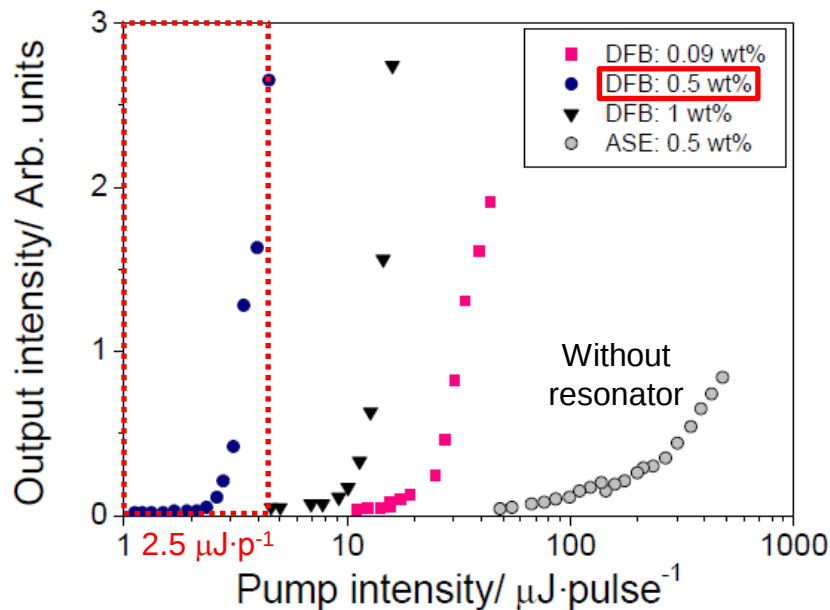
FWHM 5 nm

FWHM < 2 nm

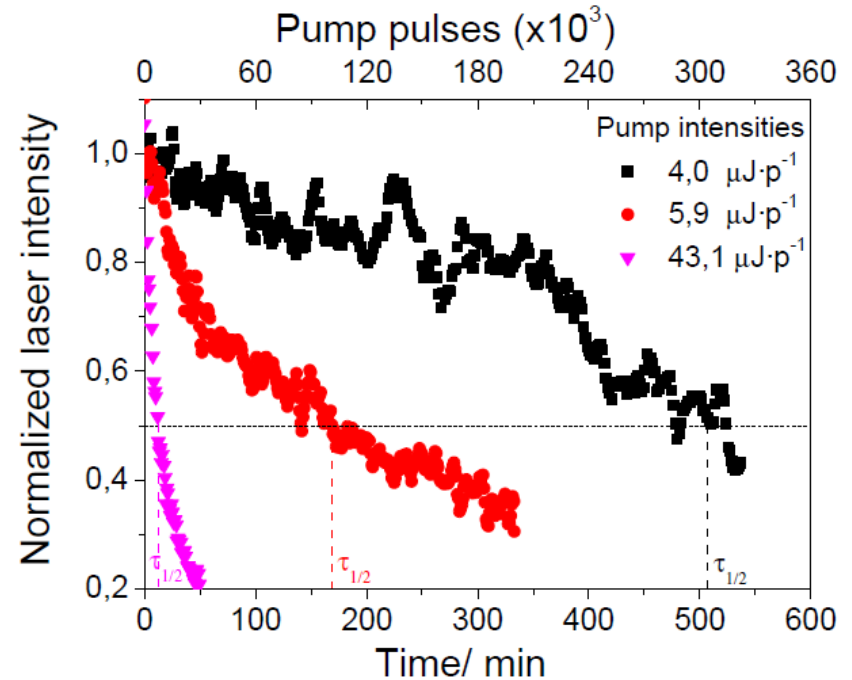
Spin-coating of the doped PS

Most remarkable properties

Lasing threshold



Photostability



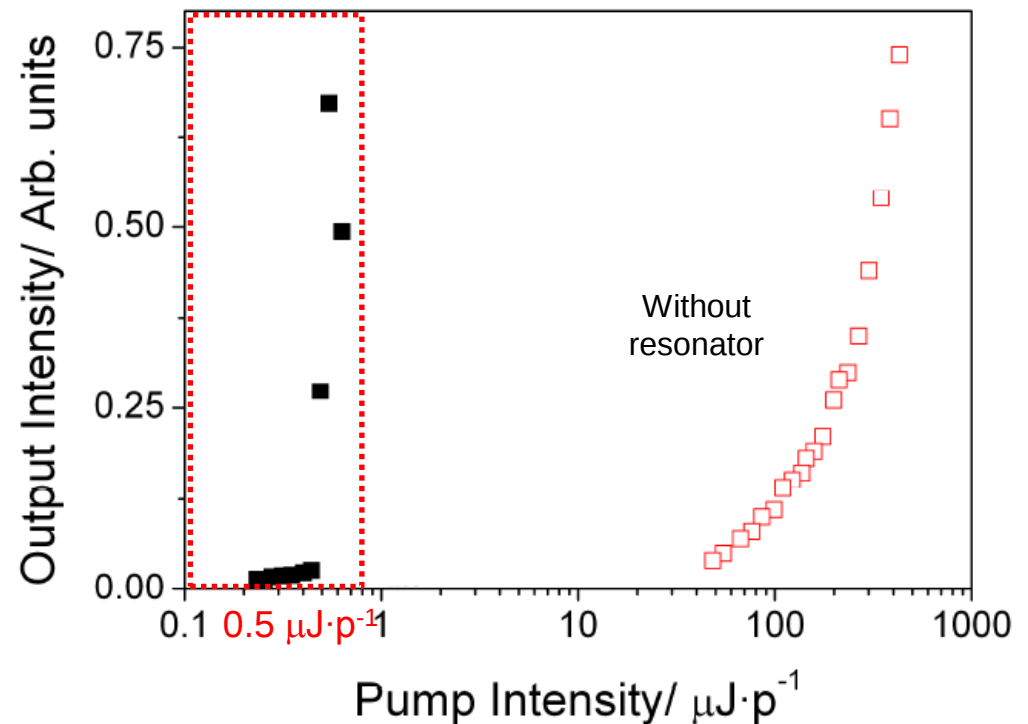
Photoestability halflife $\tau_{1/2}$:
 $\sim 3 \times 10^5$ pulses (10 ns, 4 $\mu\text{J}\cdot\text{p}^{-1}$) at 10 Hz

Fabrication of the resonator: gratings on doped PS

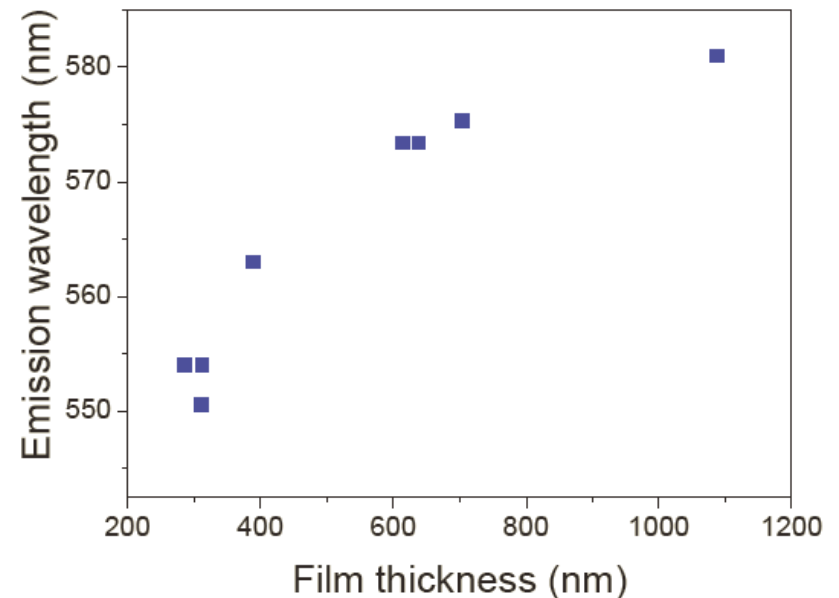
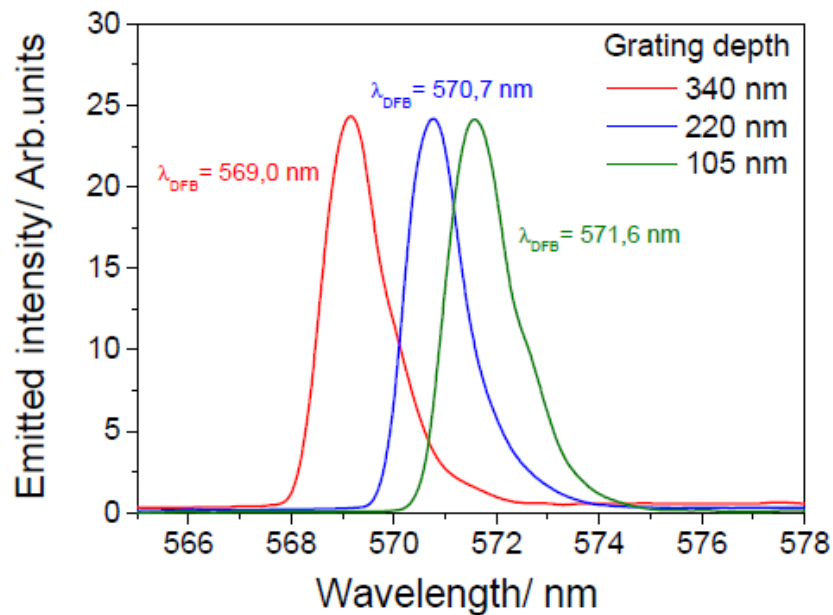


NIL onto doped PS

Lasing threshold

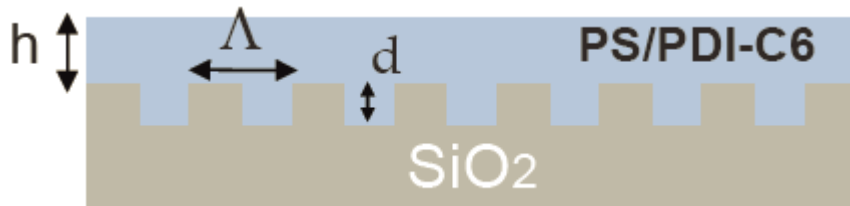


Last results: Wavelength tunability SiO₂ gratings

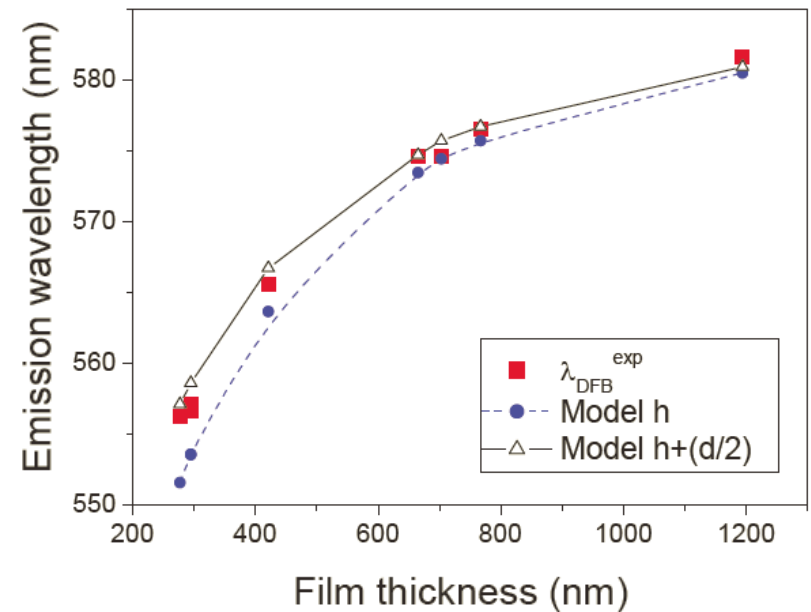


Wavelength tuning up to 30 nm
(grating depth = 220 nm)

Last results: Wavelength tunability SiO₂ gratings



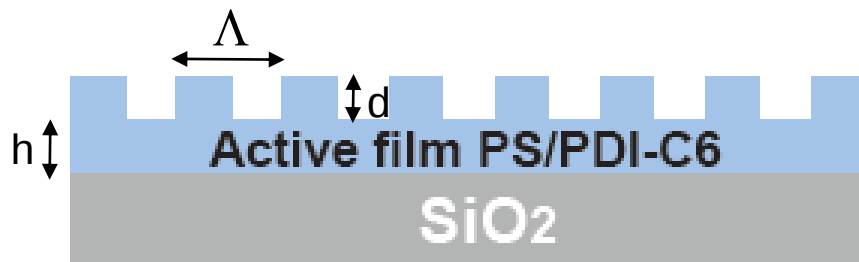
$$2\pi \frac{h}{\lambda} \cdot \sqrt{n_f^2 - n_{eff}^2} - \phi_c - \phi_s = w\pi$$



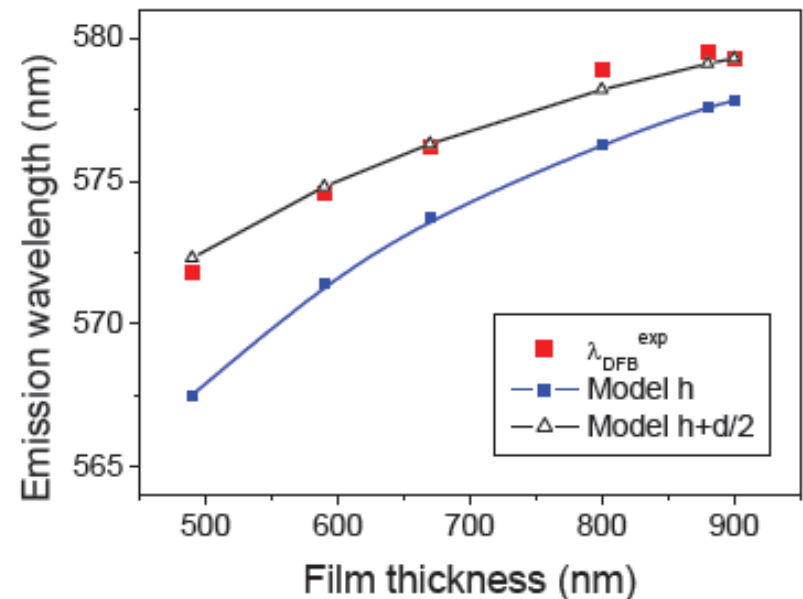
“Model h”: waveguide of thickness h

“Model h+(d/2)”: waveguide of thickness $h+(d/2)$

Last results: Wavelength tunability gratings on doped PS



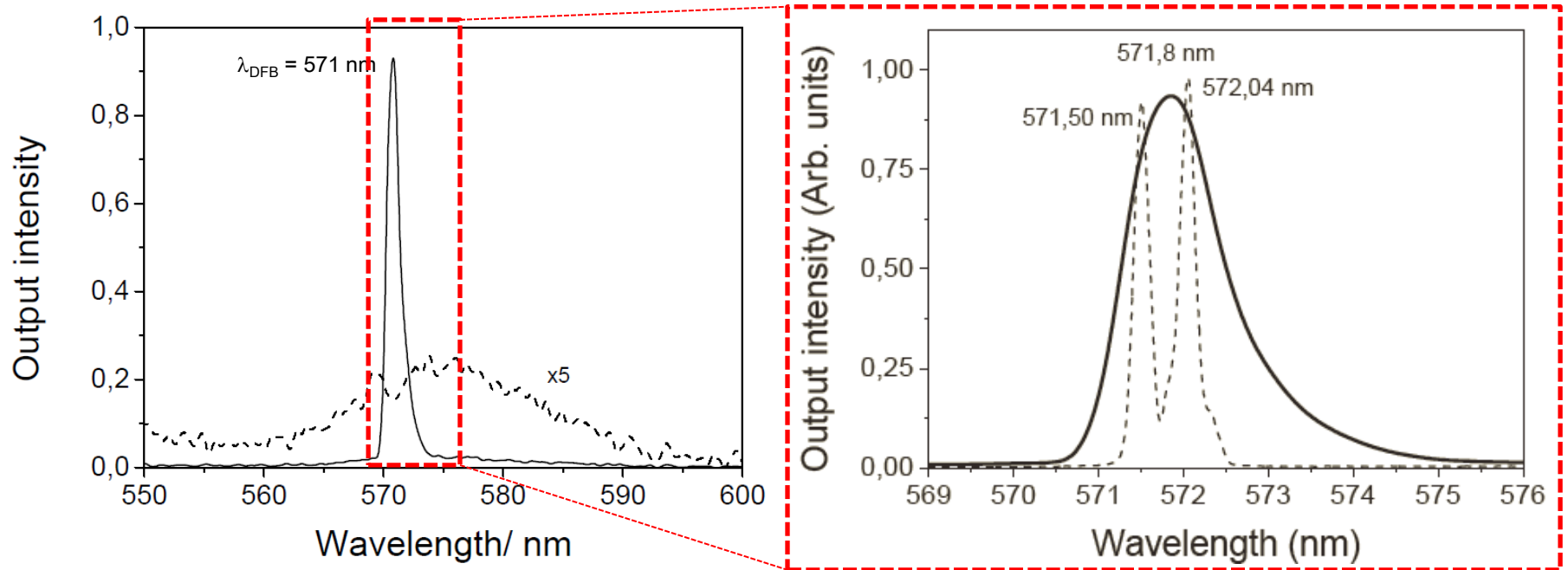
$$2\pi \frac{h}{\lambda} \cdot \sqrt{n_f^2 - n_{eff}^2} - \phi_c - \phi_s = w\pi$$



“Model h ”: waveguide of thickness h

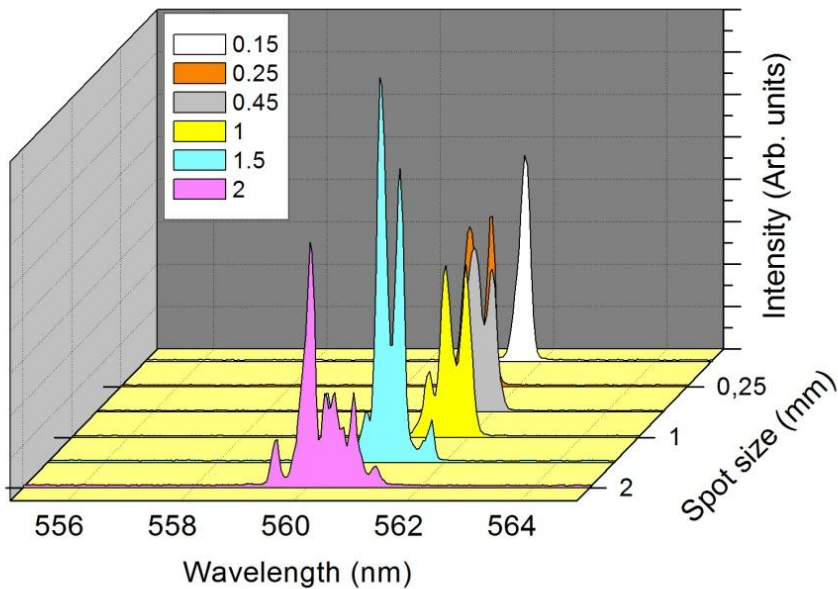
“Model $h+(d/2)$ ”: waveguide of thickness $h+(d/2)$

High resolution spectra

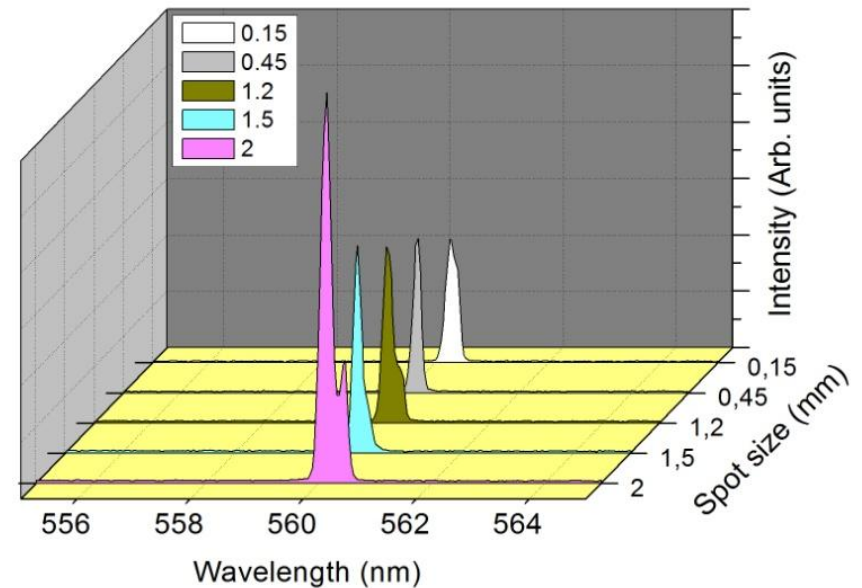


High resolution spectra

MRI7030E/S-DIPP



MRI8030E/S-DIPP



Film thickness homogeneity

Conclusions

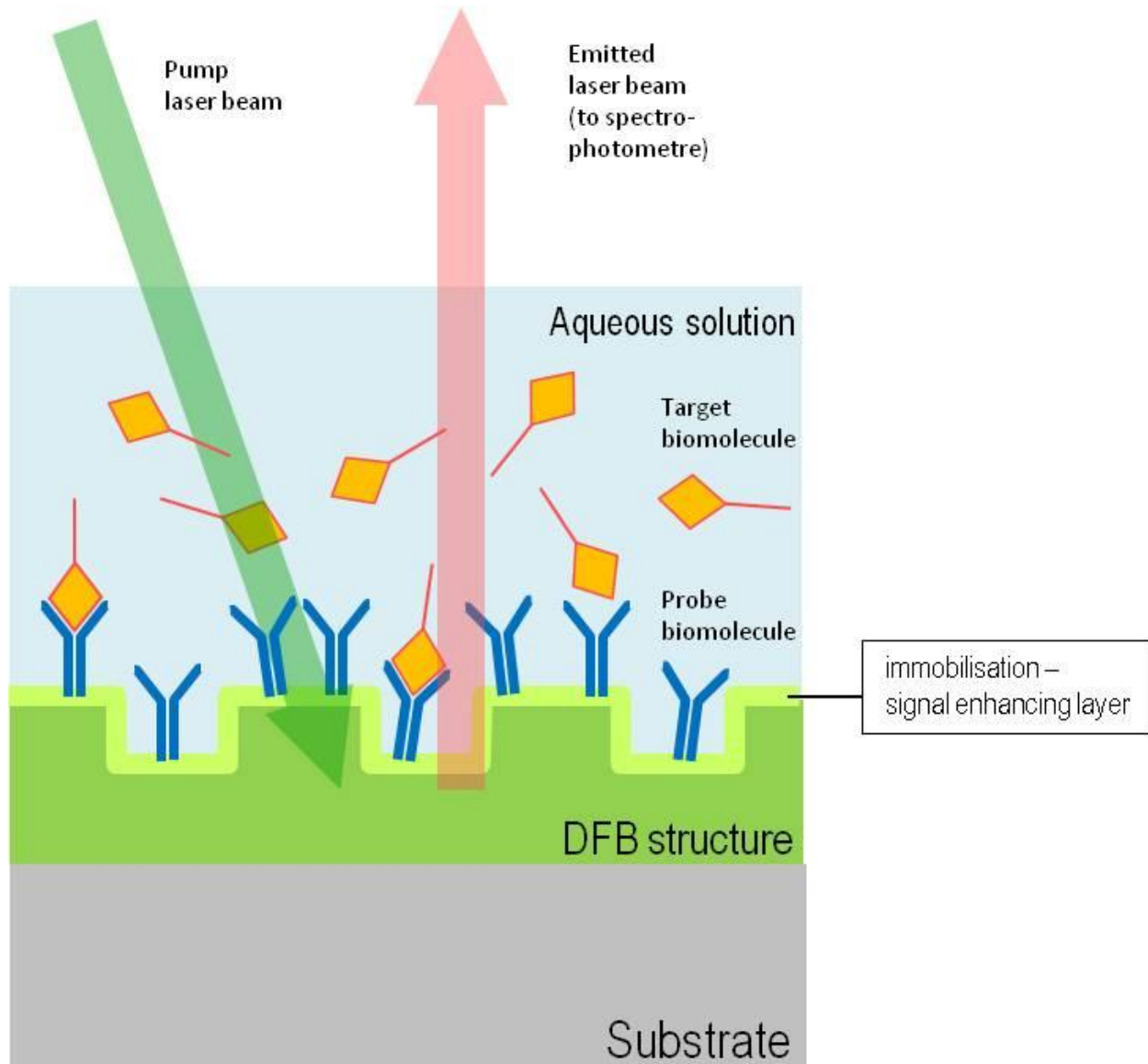
We have fabricated and characterized second-order DFB organic laser devices:

- Active medium: PS film doped with a perilenediimide derivative.
- Resonator fabricated via thermal NIL ($\Lambda = 368$ nm) in SiO_2 and active medium
- Low threshold and high photostability

Film thickness homogeneity must be improved for single-mode emission

→ Proof of concept of **biosensing** capabilities

Future work (based on work by B. T. Cunningham's group)



Acknowledgements

➤ Financial support:

- Spanish Government MEC and the European Community (FEDER).

Grant MAT2008-06648-C02.

- ETORTEK project MIBIO2 funded by the Basque Government.

- CSIC fellowship within the program JAE.

➤ V. Esteve for technical assistance.

Thank you for your attention!

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SiO₂ gratings

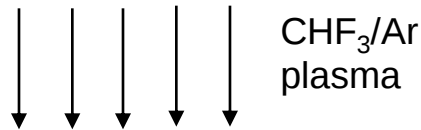
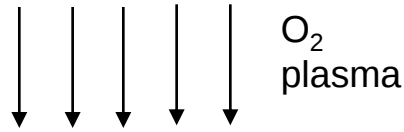
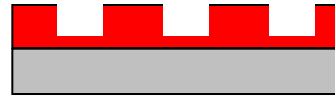
NIL onto mr-I8030E



Residual layer etching



SiO₂ etching



- Jenoptik HEX03
- 20000 N
- 180 °C
- 900 s

- 20 sccm O₂
- 20 mTorr
- 20 W

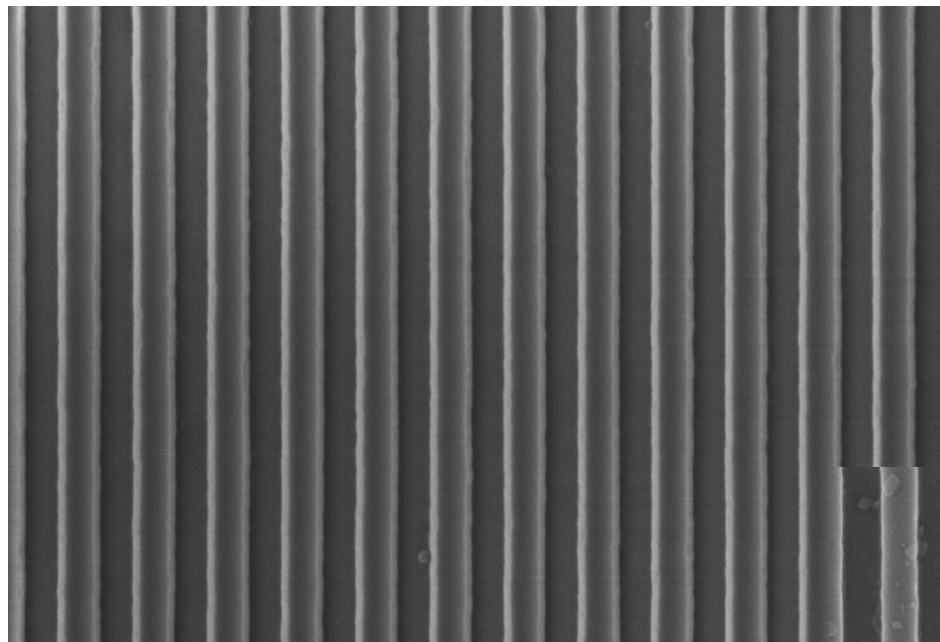
- 25 sccm CHF₃
- 25 sccm Ar
- 30 mTorr
- 200 W

- DEPTH:
 - 340 nm (10 min.),
 - 220 nm (6 min.),
 - 105 nm (3 min.)



Spin-coating of the doped PS

Fabrication of the resonator



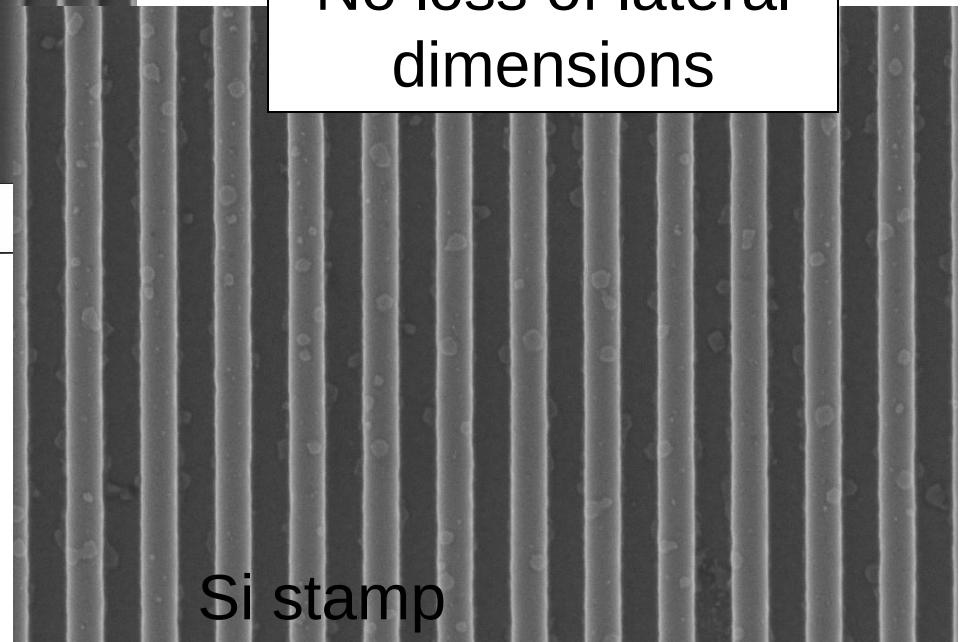
SiO₂

Si stamp

No loss of lateral dimensions

200 nm EHT = 2.00 kV Signal A = InLens Date :2 Jun 2009
WD = 2.7 mm Photo No. = 148 Time :15:25:26

SiO₂



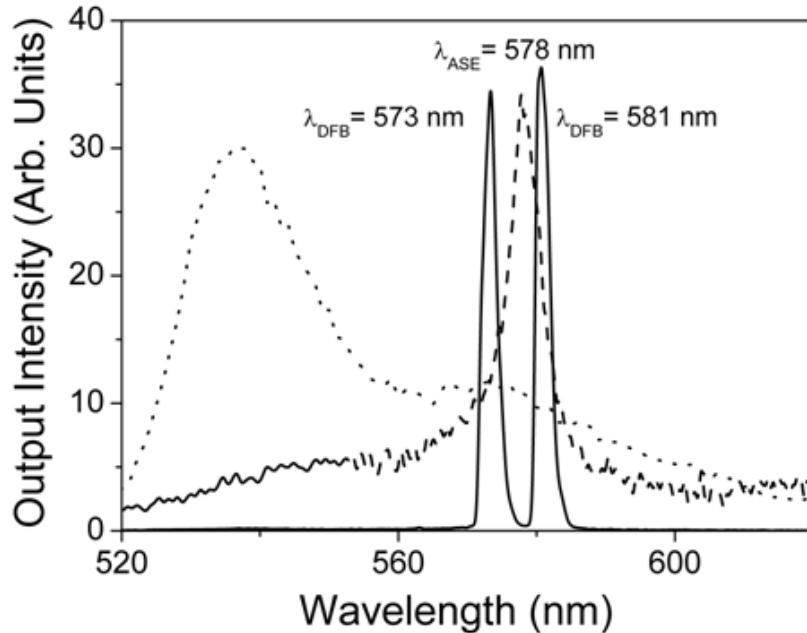
Si stamp

200 nm EHT = 2.00 kV Signal A = InLens Date :7 Sep 2009
WD = 3.2 mm Photo No. = 286 Time :9:41:24



Optical characterization

1.1 μm thickness (0.75 wt%)*



..... PL - - - Without resonator — With resonator

$\lambda_{\text{ASE}} = 578 \text{ nm}$

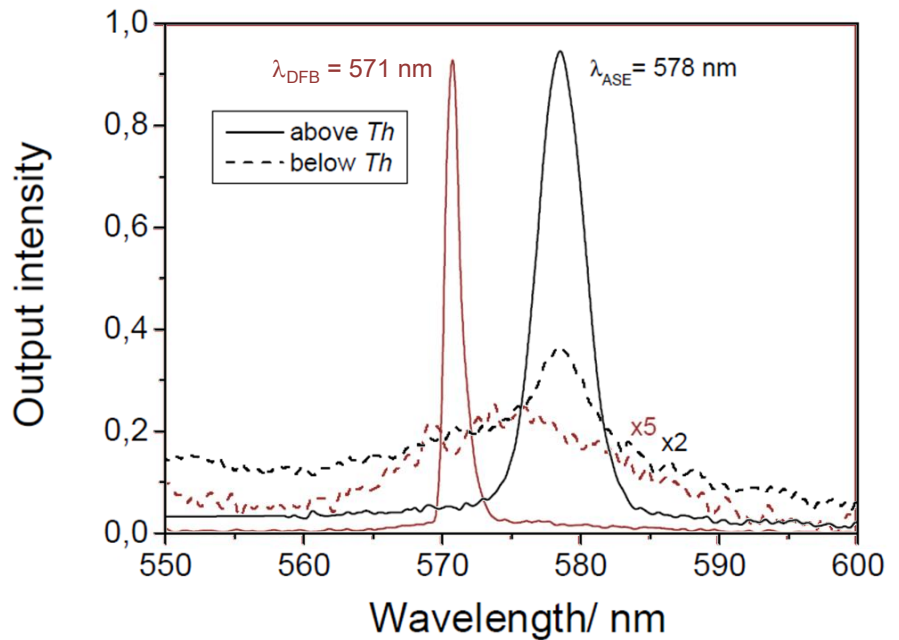
FWHM 6 nm

$\lambda_{\text{DFB}} = 573 \text{ nm}$

$\lambda_{\text{DFB}} = 581 \text{ nm}$

FWHM 2 nm

0.6 μm thickness



— Without resonator — With resonator

$\lambda_{\text{ASE}} = 578 \text{ nm}$

FWHM 5 nm

$\lambda_{\text{DFB}} = 571 \text{ nm}$

FWHM < 2 nm

* V. Trabadelo et al., *Microelectronic Engineering*, **87**, 1428–1430 (2010)

Fabrication of the resonator: gratings on doped PS

NIL onto doped PS



- Jenoptik HEX03
- 15000 N
- 155 °C
- 900 s

Easier processing!